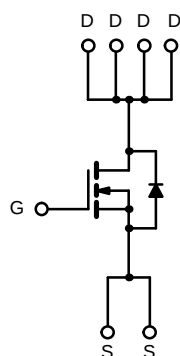
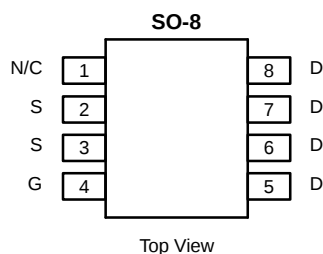




N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY

V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
30	0.030 @ $V_{GS} = 10$ V	± 7.0
	0.040 @ $V_{GS} = 5$ V	± 6.0
	0.050 @ $V_{GS} = 4.5$ V	± 5.4



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($T_J = 150^\circ\text{C}$) ^a	I_D	± 7.0	A
		± 5.8	
Pulsed Drain Current	I_{DM}	± 30	
Continuous Source Current (Diode Conduction) ^a	I_S	2.8	W
Maximum Power Dissipation ^a	P_D	2.5	
		1.6	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Limit	Unit
Maximum Junction-to-Ambient ^a	R_{thJA}	50	$^\circ\text{C/W}$

Notes

a. Surface Mounted on FR4 Board, $t \leq 10$ sec.

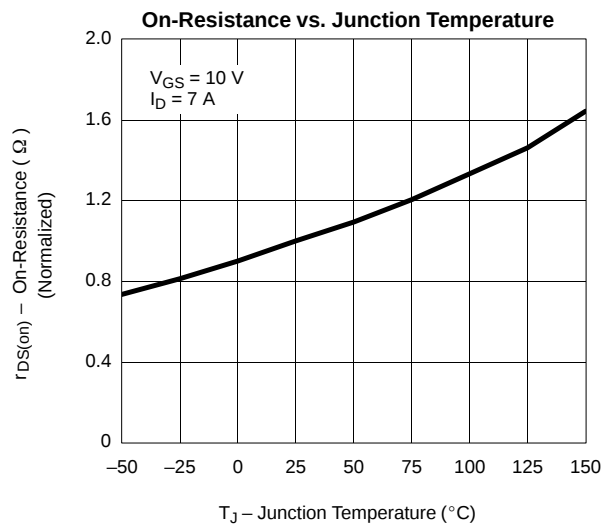
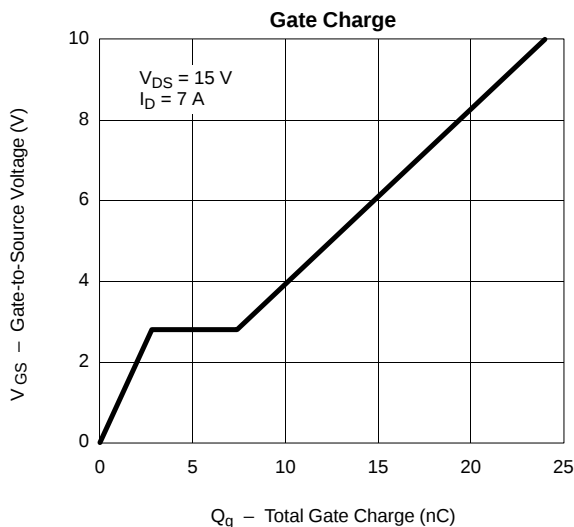
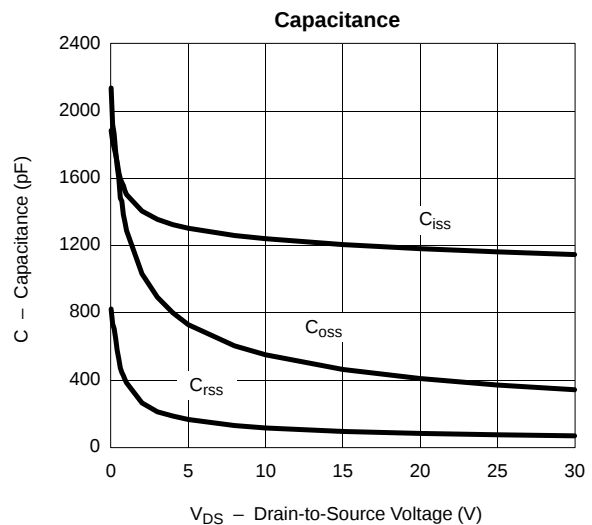
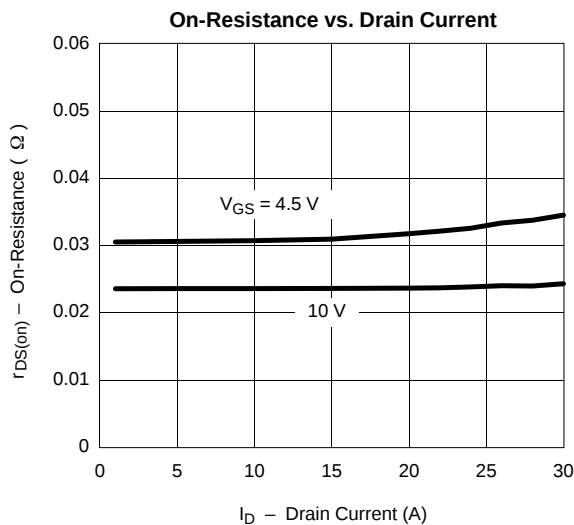
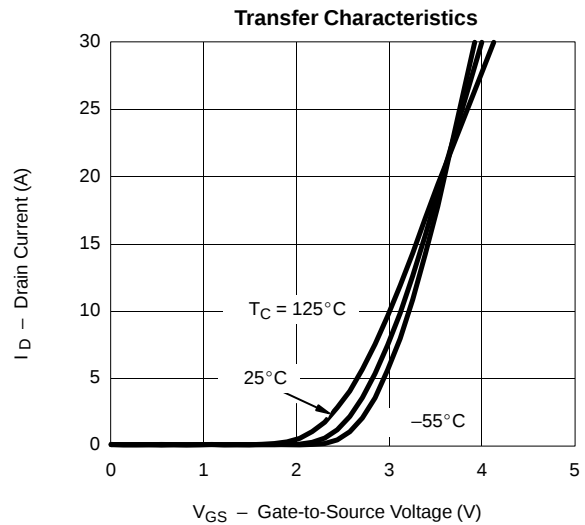
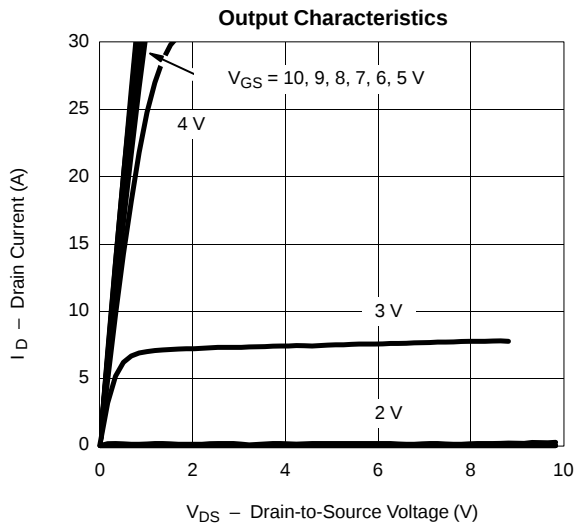
For SPICE model information via the Worldwide Web: <http://www.vishay.com/www/product/spice.htm>

SPECIFICATIONS (T_J = 25 °C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min	Typ ^a	Max	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	1.0			V
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24 V, V _{GS} = 0 V			2	μA
		V _{DS} = 24 V, V _{GS} = 0 V, T _J = 55 °C			25	
On-State Drain Current ^b	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	30			A
Drain-Source On-State Resistance ^b	r _{DS(on)}	V _{GS} = 10 V, I _D = 7.0 A		0.024	0.030	Ω
		V _{GS} = 5 V, I _D = 4.0 A		0.030	0.040	
		V _{GS} = 4.5 V, I _D = 3.5 A		0.032	0.050	
Forward Transconductance ^b	g _{fs}	V _{DS} = 15 V, I _D = 7.0 A		15		S
Diode Forward Voltage ^b	V _{SD}	I _S = 2 A, V _{GS} = 0 V		0.72	1.1	V
Dynamic^a						
Total Gate Charge	Q _g	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 2 A		24	50	nC
Gate-Source Charge	Q _{gs}			2.8		
Gate-Drain Charge	Q _{gd}			4.6		
Turn-On Delay Time	t _{d(on)}	V _{DD} = 25 V, R _L = 25 Ω I _D ≅ 1 A, V _{GEN} = 10 V, R _G = 6 Ω		14	30	ns
Rise Time	t _r			10	60	
Turn-Off Delay Time	t _{d(off)}			46	150	
Fall Time	t _f			17	140	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2 A, di/dt = 100 A/μs		60		

Notes

- a. Guaranteed by design, not subject to production testing.
b. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

